PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hyman Lam	06/05/2013
Nicholas R. Denny	06/05/2013
Joseph AuBuchon	06/05/2013
Mei Chang	06/06/2013

RECEIVING PARTY DATA

Name:	Applied Materials, Inc.
Street Address:	3050 Bowers Avenue
City:	Santa Clara
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13897327

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 7328150404

Email: Imurphy@dsiplaw.com
Correspondent Name: Servilla Whitney LLC
Address Line 1: 33 Wood Avenue South
Address Line 2: Second Floor, Suite 210
Address Line 4: Iselin, NEW JERSEY 08830

ATTORNEY DOCKET NUMBER:	017868/USA/MDP/MDP-ALD/CR
NAME OF SUBMITTER:	Jeffrey I. Blankman
Signature:	/Jeffrey I. Blankman, Reg. #57826/

502378243 REEL: 030579 FRAME: 0243

13897377

Date:	06/10/2013
Total Attachments: 2 source=00365566#page1.tif source=00365566#page2.tif	

PATENT REEL: 030579 FRAME: 0244

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors

1)	Hyman Lam 529 S. 7th Street Apt. 3 San Jose, CA, 95112 United States of America
2)	Nicholas R. Denny 1019 Chula Vista Terr. Sunnyvale, CA 94086 United States of America
3)	Joseph AuBuchon 1641 Garvey Place San Jose, CA, 95132 United States of America

4)	Mei Chang
,	12881 Corte De Arguello
	Saratoga, CA, 95070
	United States of America

(hereinafter referred to as Assignors), have invented a certain invention entitled:

"Deposition Chambers With UV Treatment And Methods Of Use"

for which application for Letters Patent in the United States was filed on May 17, 2013,

under Serial No. 13897327, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, CA, 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of

any of said Patents.

- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1) 06/05/22, 2013 // (INVENTOR) Hyman Lam

2) 6/5/, 2013 // (INVENTOR) Nicholas R. Denny

3) 6/5/, 2013 // (INVENTOR) Joseph AuBuchon

4) 6/6/26/3, 2013 // (INVENTOR) Mei Chang